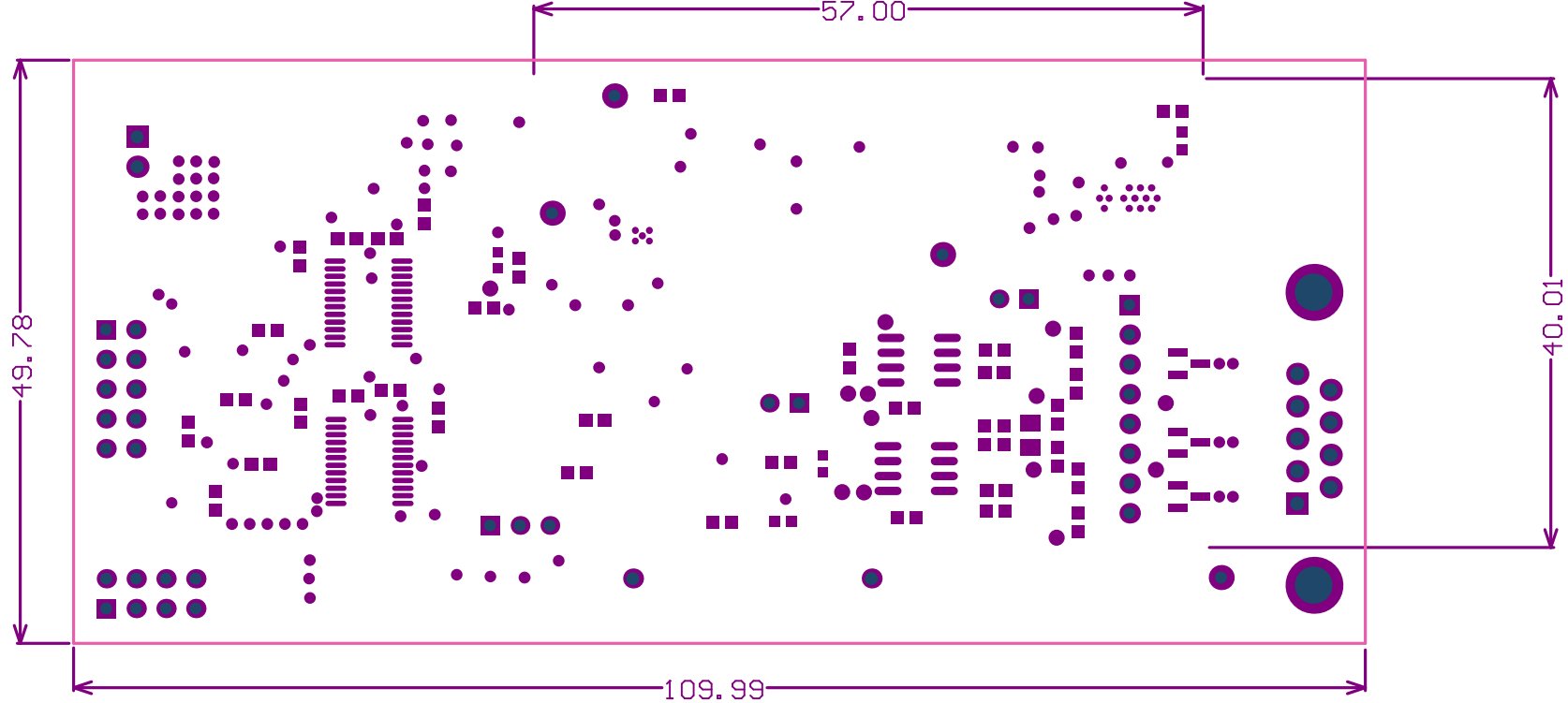
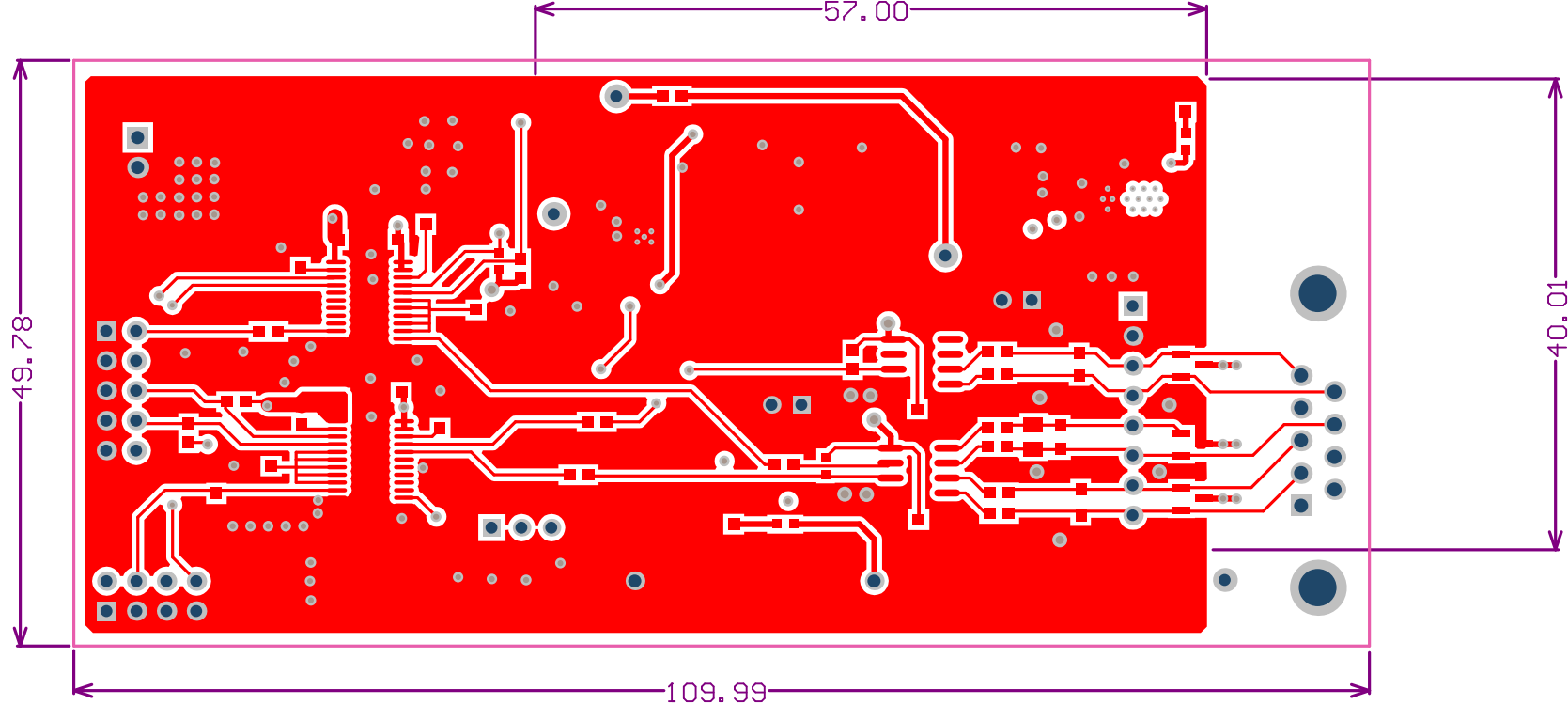


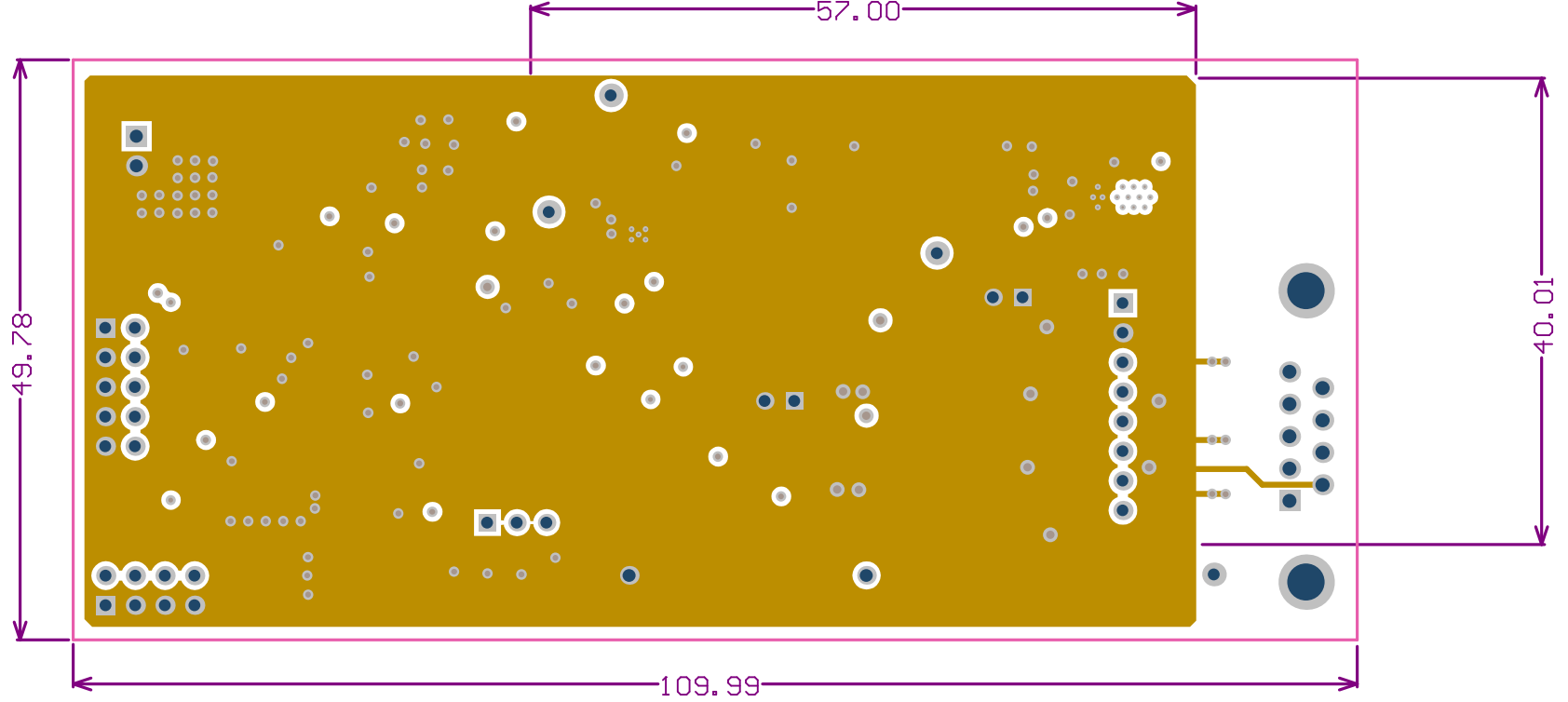
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME =                     |                                  |                   |                                |
| PLOT NAME = Top Overlay          | GENERATED : 6/20/2014 7:35:37 PM | TEXAS INSTRUMENTS |                                |



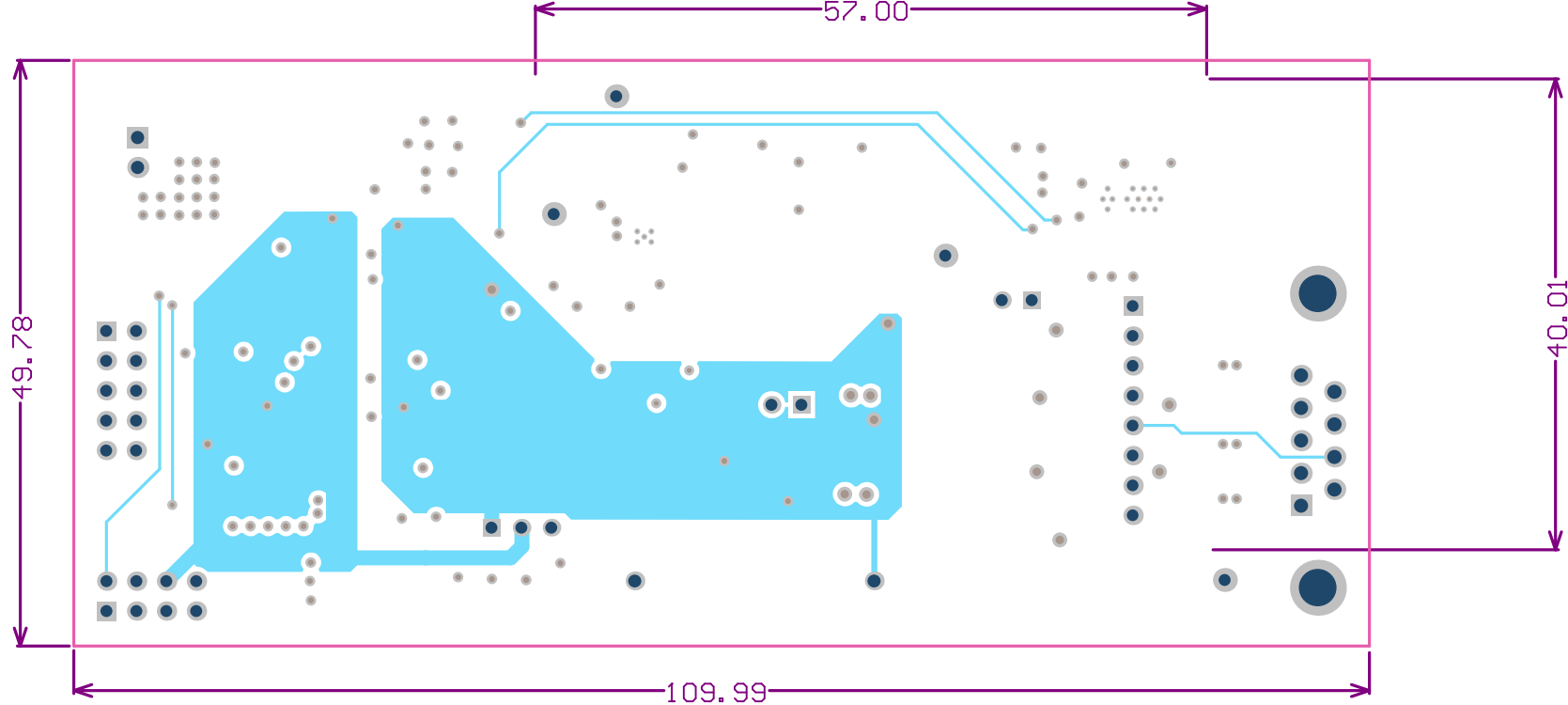
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME =                     |                                  |                   |                                |
| PLOT NAME = Top Solder Mask      | GENERATED : 6/20/2014 7:35:38 PM | TEXAS INSTRUMENTS |                                |



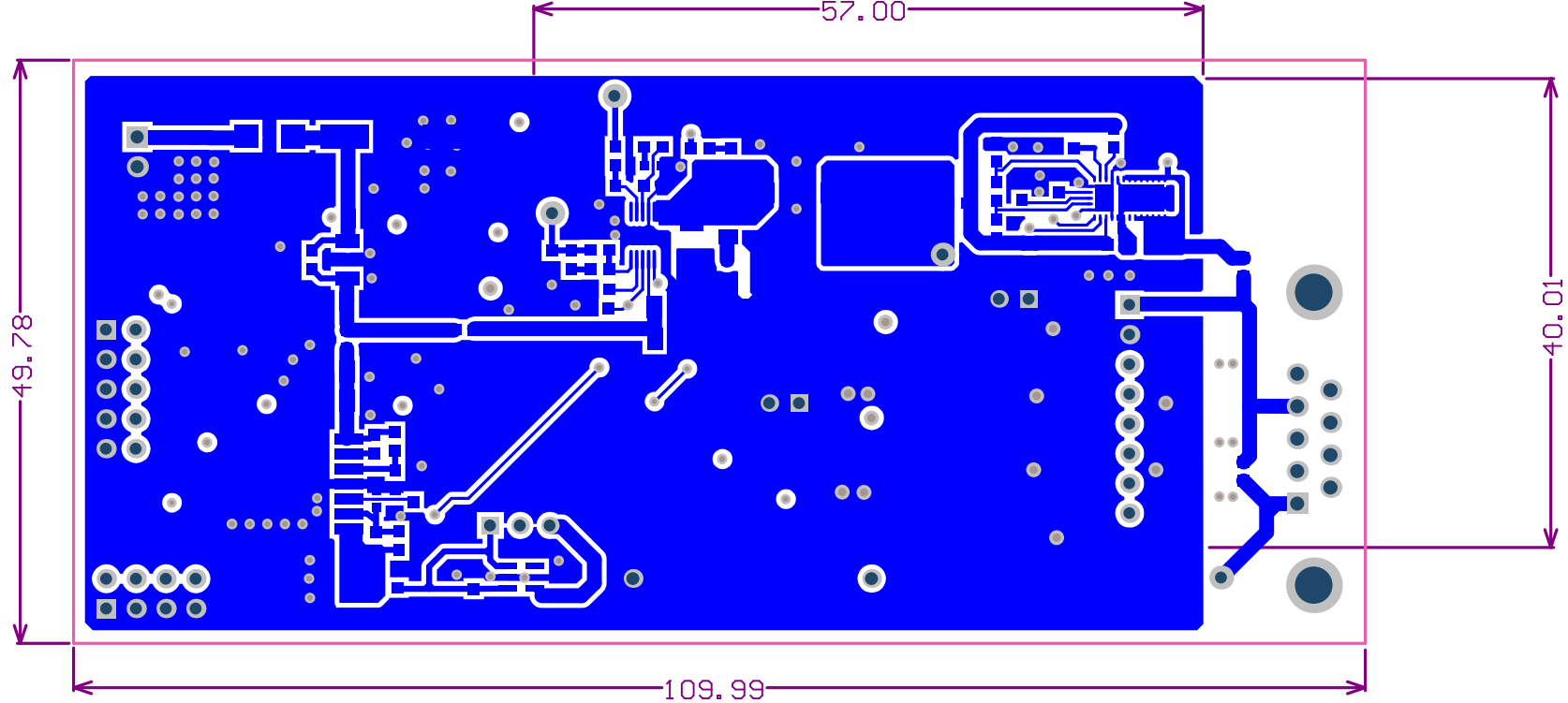
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME = Top Layer           |                                  |                   |                                |
| PLOT NAME = Top Layer            | GENERATED : 6/20/2014 7:35:39 PM | TEXAS INSTRUMENTS |                                |



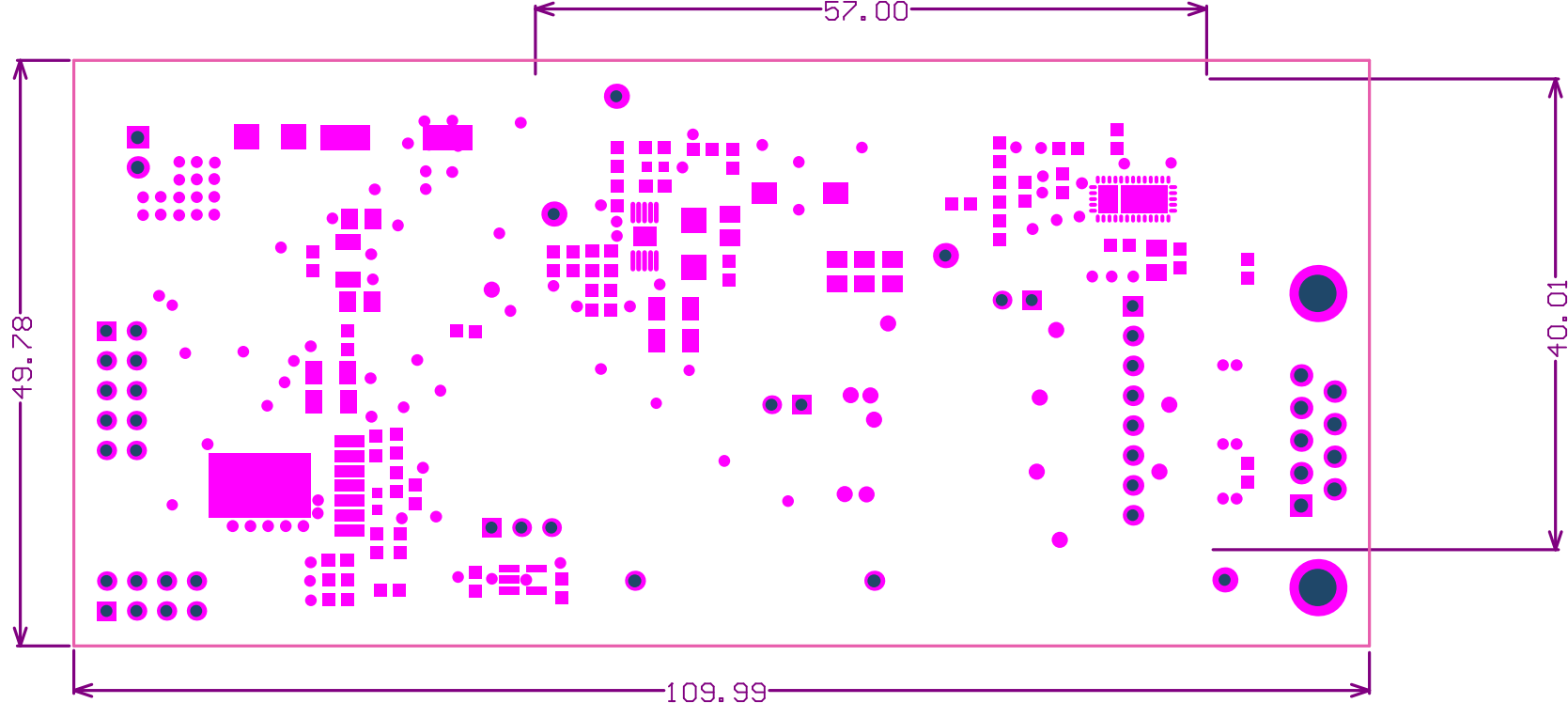
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME = mid layer 1-GND     |                                  |                   |                                |
| PLOT NAME = Mid Layer 1 - GND    | GENERATED : 6/20/2014 7:35:39 PM | TEXAS INSTRUMENTS |                                |



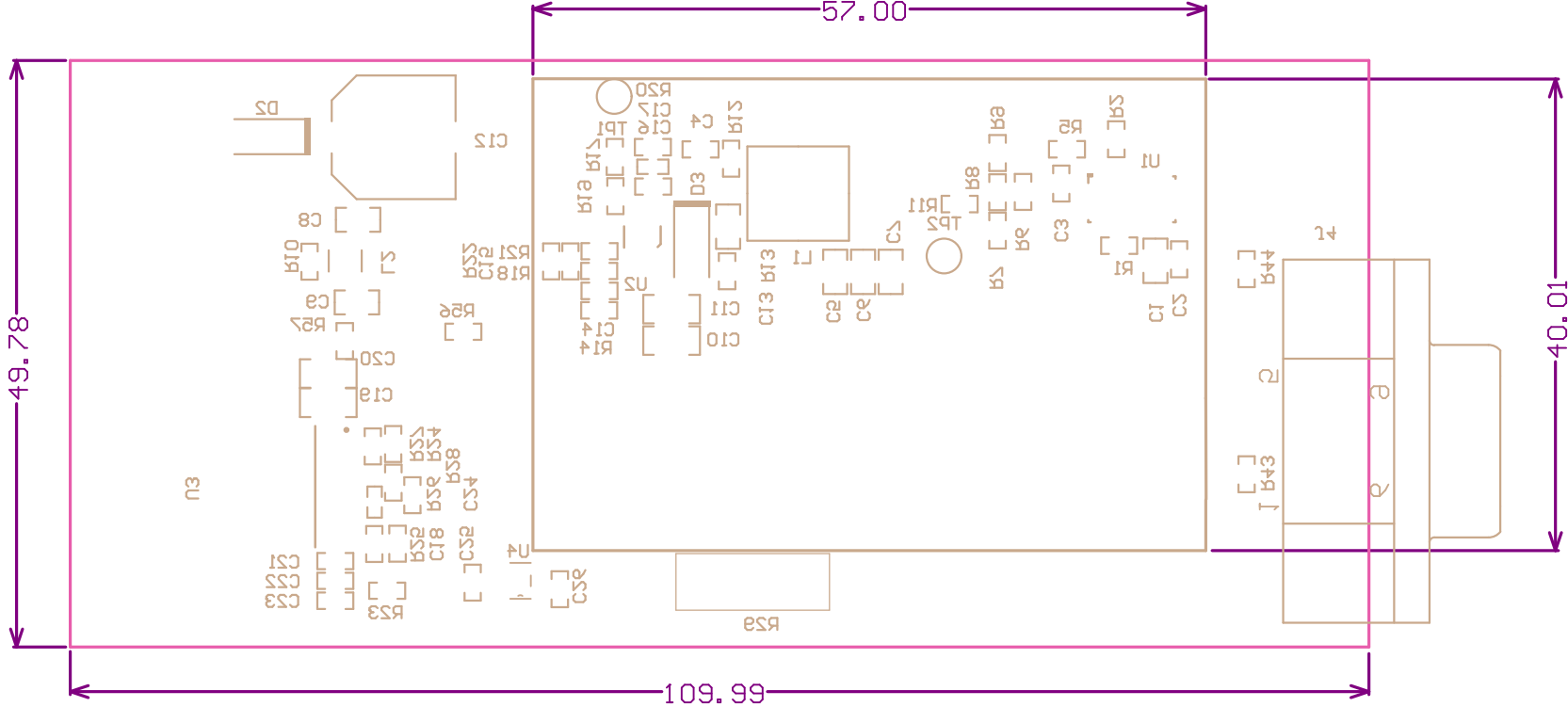
|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME = mid layer 2-VCC     |                                  |                   |                                |
| PLOT NAME = Mid Layer 2 - VCC    | GENERATED : 6/20/2014 7:35:40 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME = Bottom Layer        |                                  |                   |                                |
| PLOT NAME = Bottom Layer         | GENERATED : 6/20/2014 7:35:41 PM | TEXAS INSTRUMENTS |                                |

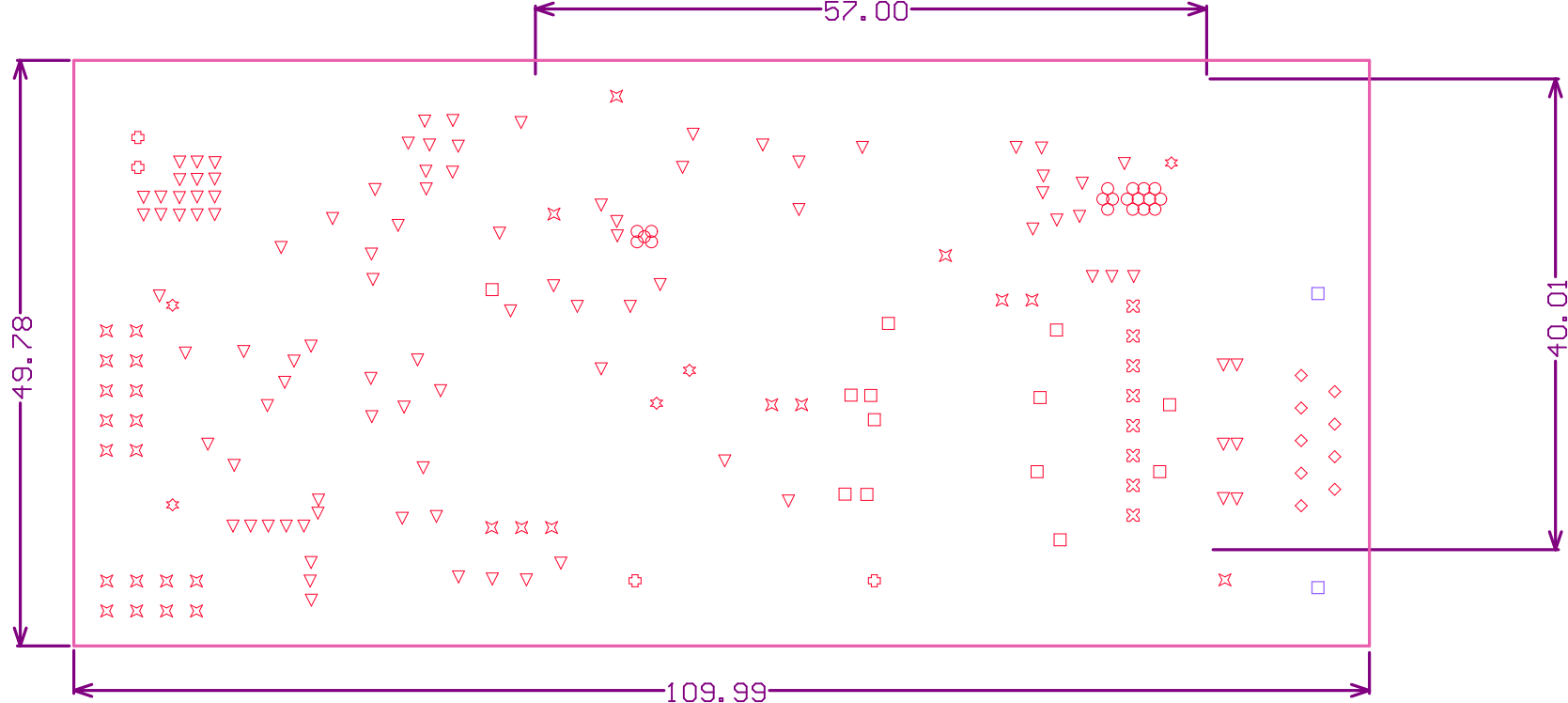


|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME =                     |                                  |                   |                                |
| PLOT NAME = Bottom Solder Mask   | GENERATED : 6/20/2014 7:35:42 PM | TEXAS INSTRUMENTS |                                |



|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME =                     |                                  |                   |                                |
| PLOT NAME = Bottom Overlay       | GENERATED : 6/20/2014 7:35:42 PM | TEXAS INSTRUMENTS |                                |





|                                  |                                  |                   |                                |
|----------------------------------|----------------------------------|-------------------|--------------------------------|
| ALL ARTWORK VIEWED FROM TOP SIDE | BOARD #: TIDA-00175              | REV: E1           | SVN REV: Not In VersionControl |
| LAYER NAME =                     |                                  |                   |                                |
| PLOT NAME = Drill Drawing        | GENERATED : 6/20/2014 7:35:43 PM | TEXAS INSTRUMENTS |                                |

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